

Enhanced electromechanical coupling of piezoelectric beams through an innovative design

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Enhanced electromechanical coupling of piezoelectric beams through an innovative design













2. Solution and simulations



3. Experimental validation





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Context

Solution

Experiments

Vibration energy harvesting



Challenge

- Linear harvesters efficiencies drastically decrease if their resonant frequency do not match the vibration's frequency
- The intrinsic resonant frequency of piezoelectric energy harvesters may also varies with time, due to aging.

Context

 Δf : Frequency bandwidth



Necessity to either enlarge the harvesting bandwidth, or tune the harvester's resonant frequency

Solution





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Principle



 \rightarrow Increasing the coupling k^2 increases the frequency bandwidth Δf

¹ A. Morel *et al.*, SMS, 2018

Electromechanical coupling coefficient



Cantilever optimization



Long proof mass useful to increase coupling coefficient as the strain becomes uniform

Material thicknesses should be optimized

Gibus et al., Applied Energy 2020



Material coupling



Material coupling

Take benefit of material parameters



Beam width should be at least twice bigger than the length for piezoelectric ceramics but
As ↗ beam length helps to ↘ resonant frequency, design issues can occur for small devices volumes and with low resonant frequencies

Is it possible to reach with this behavior without enlarging the beam ?

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Context

Solution

Experiments

Innovative design

Proposal : adding latteral bars to reduce lateral strain for narrow beams



Example with PMN-PT Material on Comsol (FEM)



Context



Parametric study

The improvement of the coupling depends on

The initial cantilever

- \circ Coupling coefficients $k_{31}^{l}^{2}$ and $k_{31}^{w}^{2}$ of the piezoelectric material,
- $^{\circ}\,$ The stiffness of the piezoelectric material and the substrate
- The geometry (length of the beam, mass and thickness of the piezoelectric materials and the substrate)

• The bars

- $^{\circ}\,$ Dimensions (height h_{bar} , length L_{bar})
- The stiffness of the material of the bars
- Number and arrangement (distance between each bar, staggered or face to face arrangement)







Parametric study

Fixed parameters	Values			
Materials	PZT 4 and steel			
Beam width	15 mm			
Bar width L_{bar}	1 mm			
Beam length	45 mm			
Variable parameters				
Bar thickness h_{har}	0.25-0.5-1-2.5-5-7.5-10 mm			
Substrate and piezo thicknesses $(h_p = h_s)$	0.3-0.4-0.5-0.6-0.7-0.8-0.9mm			





h_{bar} sould be maximized and a plateau is reached



Parametric study



An optimal value of L_{bar} exists According to our first studies, the bars should cover around 8 % of the beam length

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Preliminary conclusion





Parameters	Optimal configuration
Bar thickness h_{bar}	At least $4 \times$ substrate thickness (h_s)
Bar width L_{bar}	Around 8 % of the beam length
Number of bars	At leat 3 one each side. No significant tendency with more bars
Arrangement (staggered of face to face)	No significant tendency





2. Solution and simulations



3. Experimental validation

Context



Experiments



Initial device



 $\begin{array}{ll} f_{sc} = 26.6 \ \text{Hz} & f_{sc} = 25.6 \ \text{Hz} \\ k^2 = 10.5 \ \%^* & k^2 = 9.5 \ \% \end{array}$

* Considered glue thickness of 100 μ m between the piezoelectric plates and the substrate, and considered distance of the piezoelectric plates from clamp of 500 μ m



Bimorph :

- 1 mm thick aluminum substrate
- 2 \times 0.5 mm thick PZT 5H plates
- 10 mm thick steel proof mass



Pmax=130 μW @ 0.2 m/s²

8.5 % bandwidth at Pmax/2

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Enhanced device

Results





 $f_{sc} = 28.2 \text{ Hz}$ $k^2 = 14.3 \%^*$

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Context

* Considered glue thickness of 100 µm between the bars and the piezoelectric plates

Measure admittance and fit



Solution

- 6 Bars:
 - 2 mm x 3 mm steel bars
 - 3 on each side
 - staggered arrangement



Pmax=130 μW @ 0.2 m/s²

10.5 % bandwidth at Pmax/2

 k^2 is multiplied by 1.42 with the bars (from 9.5 % to 13.7%)

Experiments

The **bandwidth** is expected to be **multiplied by 1.23**



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Conclusion





Conclusion

An innovative design was presented for maximizing the coupling

- $^{\circ}$ to maximize the power
- to maximize the frequency bandwidth

Experimental validation was made with PZT 5H

- $_{\circ} imes$ 1.42 on the electromechanical coupling coefficient k^2
- $_{\circ}$ \times 1.24 expected on the frequency bandwith

Prospects

- Deeper analysis of the materials impact
- Validation with lead free materials









ΕΥΧΑΡΙΣΤΩ

(Thank you)

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